Bodo's Wide Bandyap Event "Making WBG Designs Happen"

Program SiC Room Munich I

08:30	What it takes to make it real: Opportunities and challenges moving to 1500-V architectures	11:45	Lunch Break & Tabletop Exhibition
	Guy Moxey Wolfspeed	13:30	For Reliable and Competitive SiC Power Converter Dr. Nils Soltau
08:45	Hidden pits of SiC MOSFET benchmarking and evaluation Aleš Loid STMicroelectronics	13:45	Mitsubishi Electric Powering the Future: Harnessing 2kV SiC for a Decentralized Grid Emiliano Meza
09:00	Application Stability of Fast Switching Planar SiC MOSFETS Dr. David Sheridan Alpha and Omega Semiconductor	14:00	Semikron Danfoss SiC power module challenges for EV applications Imane Fouaide ROHM Semiconductor
09:15	Pushing the SiC portfolio boundaries - 400V and 3.3kV SiC MOSFETs Dr. Peter Friedrichs Infineon	14:15	Accurate SiC Simulation in SPICE and PLECS Dr. Didier Balocco onsemi
09:30	Coffee Break & Tabletop Exhibition	14:30	2 nd Generation 1200 V SiC MOSFET: Robust against Radiation and Better in R _{DS,on}
10:15	Soft-switching for Automotive Traction Inverter Applications Dr. Ajay Poonjal Pai		Hadiuzzaman Syed Bosch
	Sanan Semiconductors	14:45	Coffee Break & Tabletop Exhibition
10:30	GaN & SiC Technologies Enable Next-Gen Al Data Centers Alfred Hesener Navitas	15:30	Use cases of SiC Technology in industrial Applications David Chilachava Vincotech
10:45	SiC Power Packaging Unlocks Full Potential of High-Power Applications Dr. Ing. Tomas Krecek	15:45	SiC MOSFET with high temperature stability Dr. Georgio El-Zammar Nexperia
11:00	Microchip Technology Utilizing Physics-Based AI-Powered Digital Twins to Accelerate Design Optimization and Manufacturing Yield of SiC Power Devices	16:00	Challenges of measuring high-voltage Wide Bandgap devices Dr. Alexander Küllmer Rohde & Schwarz
	Dr. Josef Weinbub Silvaco	16:15	SiC Inverter Control Modules & Reference Designs How to increase efficiency and accelerate time to
11:15	50% more power from SiC chips in high performance ceramic-isolated discrete packages Francois Perraud		market Mike Sandyck CISSOID
11:30	Littelfuse Enhanced laser annealing for ohmic contact formation for SiC power devices Maurice Clair 3D-Micromac	16:30	SiC MOSFET 750 V Generation 2: enhancing bidirectional charging of electric vehicles and boosting their performance Mario Zotes Infineon

Program GaN Room Munich II

08:30	GaN innovations: solutions creating value in power electronics Oliver Bleck Infineon	11:4 13:3
08:45	Humanoid Robots Dexterity Powered by GaN FETs and ICs Marco Palma Efficient Power Conversion (EPC)	13:4
09:00	Now Rated to 1700V, is GaN Set to Replace SiC Above a Kilovolt? Balu Balakrishnan Power Integrations	14:0
09:15	Kiss your heatsink goodbye: A kilowatt motor inverter based on GaN Stanislav Divín STMicroelectronics	14:1
09:30	Coffee Break & Tabletop Exhibition	14:3
10:15	Price competitive GaN power devices are the technology of choice for high-efficiency, compact and cost-effective power systems Dr. Denis Marcon	14:4
10:30	Innoscience Europe Utilization of GaN in Industrial Power Module Packages David Chilachava Vincotech	15:3
10:45	Powering the Future : ICeGaN's role in redefining power supply performance for Next- Gen Data Centres Farhan Beg Cambridge GaN Devices	15:4
11:00	Maximizing application benefits with GaN: a comparison of commercial technologies Dario Pagnano Nexperia	16:0
11:15	D ³ GaN is breaking the boundaries of EV inverter efficiency Hans Winter	16:1
11:30	VisIC Technologies Using TCAD to understand GaN design dependencies for Electric Vehicle applications Andrew Patterson	16:3

Silvaco

11:45	Lunch Break & Tabletop Exhibition
13:30	Driving electric Motors with GaN power ICs Alfred Hesener Navitas
13:45	Smart power GaN technology for higher energy efficiency Gabriele Gherdovich STMicroelectronics
14:00	How to improve efficiency in solar power systems with wide bandgap devices Harald Parzhuber Texas Instruments
14:15	GaN Advantage in Multilevel Totem Pole PFC Marco Palma Efficient Power Conversion (EPC)
14:30	Monolithic Bidirectional GaN-Device: Opportunity and Challenges for Highly Efficient Design of Power Electronics Converters Dr. Reza Barzegarkhoo Kiel University
14:45	Coffee Break & Tabletop Exhibition
15:30	Theoretical Insights and Modeling of Vertical GaN Switches for Industrial Applications Dr. Samaneh Sharbati University of Southern Denmark
15:45	Overcoming Measurement Challenges in High-Speed GaN/SiC Power Devices Marcus Sonst Rohde & Schwarz
16:00	Real-time simulation for SiC/GaN devices with 1.5 MHz switching frequency Dr. Enrique Rodriguez Diaz Plexim
16:15	Innovative approaches to improve accuracy in dynamic switching characterization and Rds ON measurement Andrea Vinci Tektronix
16:30	Bi-directional GaNFast for next generation high-performance topologies Alfred Hesener Navitas

Tabletop Exhibitors



Converters









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